

A green road sign on a wooden post stands on the left side of a desert road. The road stretches into the distance towards a building on a hill under a sunset sky with scattered clouds. The sign contains the text "The eGaN® FET Journey Continues".

The eGaN® FET
Journey Continues

**Performance comparison using
eGaN® FETs in 6.78 MHz class E and
ZVS class D Wireless Power Transfer**

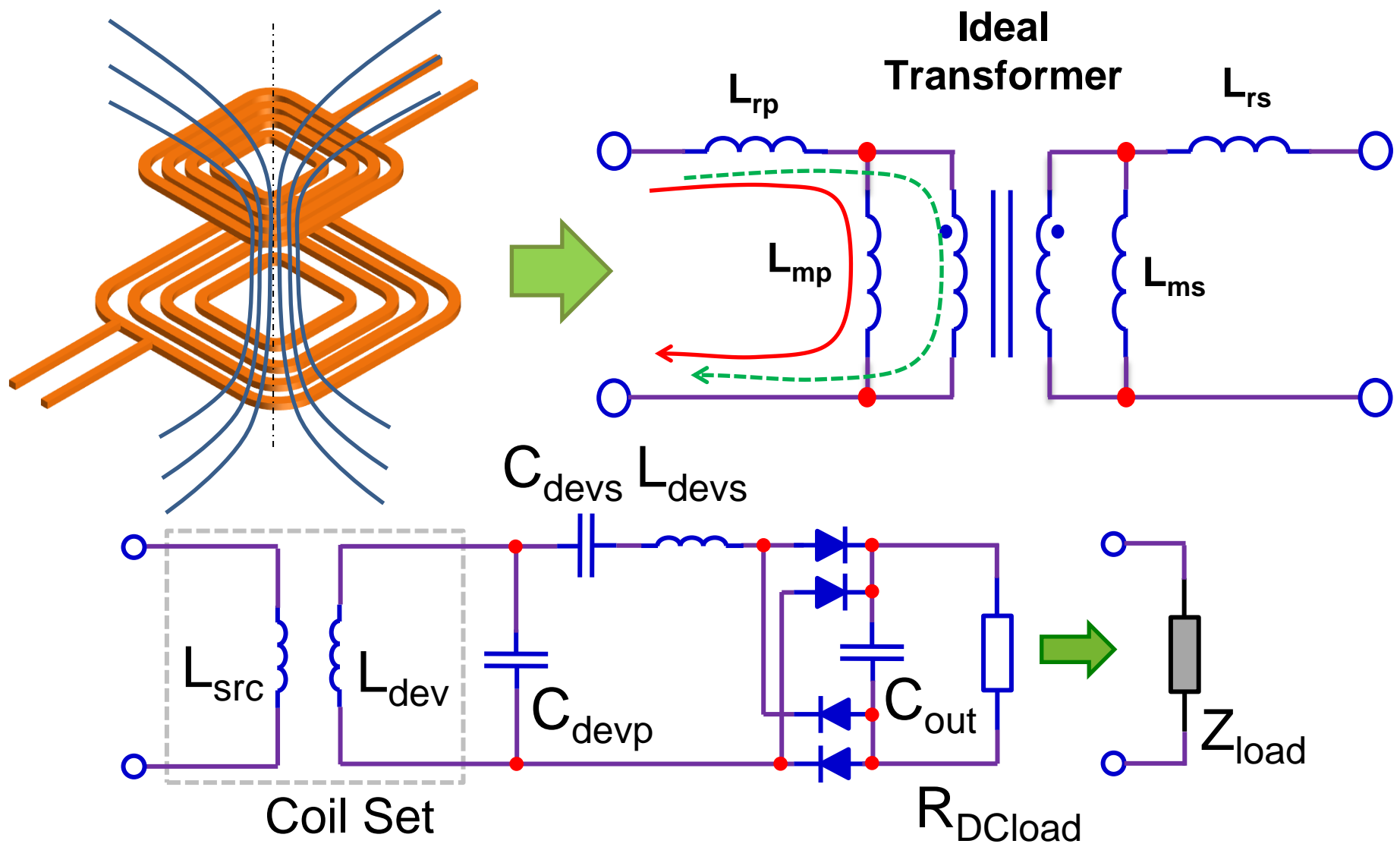
Michael de Rooij

Efficient Power Conversion Corporation

- Why Wireless Energy
- Wireless Coil Overview
- Class E for Wireless Power Overview
- ZVS Class D for Wireless Power Overview
- Why eGaN[®] FETs for Wireless Energy Transfer
- Device comparison
- Experimental performance
- Summary

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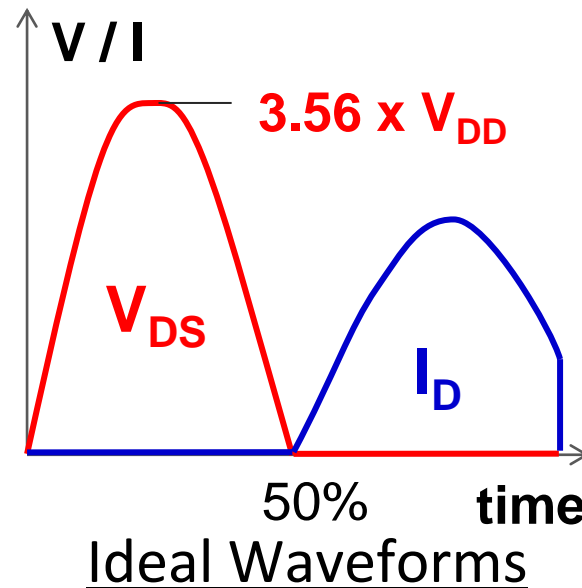
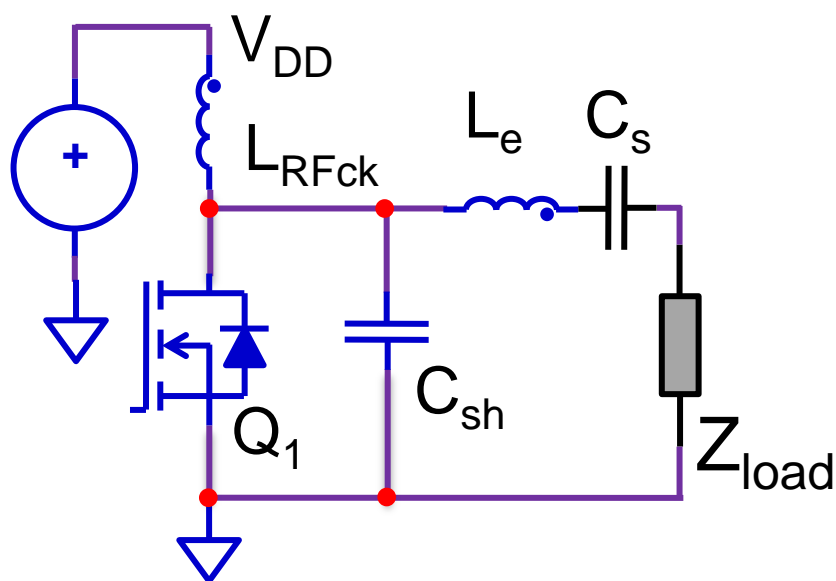
Wireless Coil-Set Overview



- Mobile device charging
 - Convenience
 - Extended battery life
- Medical Implants
 - Quality of life improvement
 - Life extender
- Hazardous environment systems
 - Explosive atmosphere
 - Corrosive locations
 - High Voltage

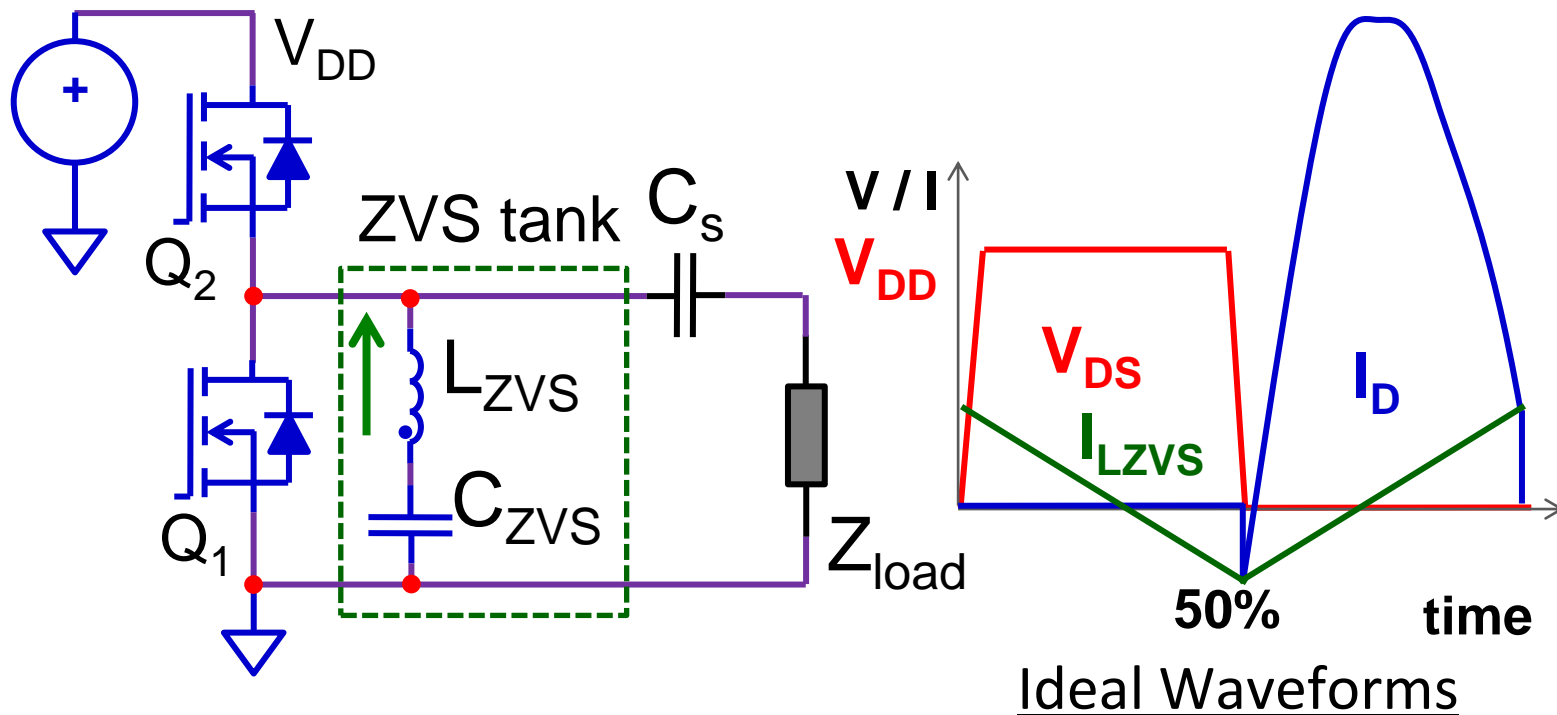


- Switch voltage rating $\geq 3.56 \cdot \text{Supply } (V_{DD})$.
- C_{OSS} "absorbed" into matching network.
- Susceptible to load variation - high FET losses
- Coil Voltage $\approx 0.707 \cdot V_{DD} [V_{RMS}]$



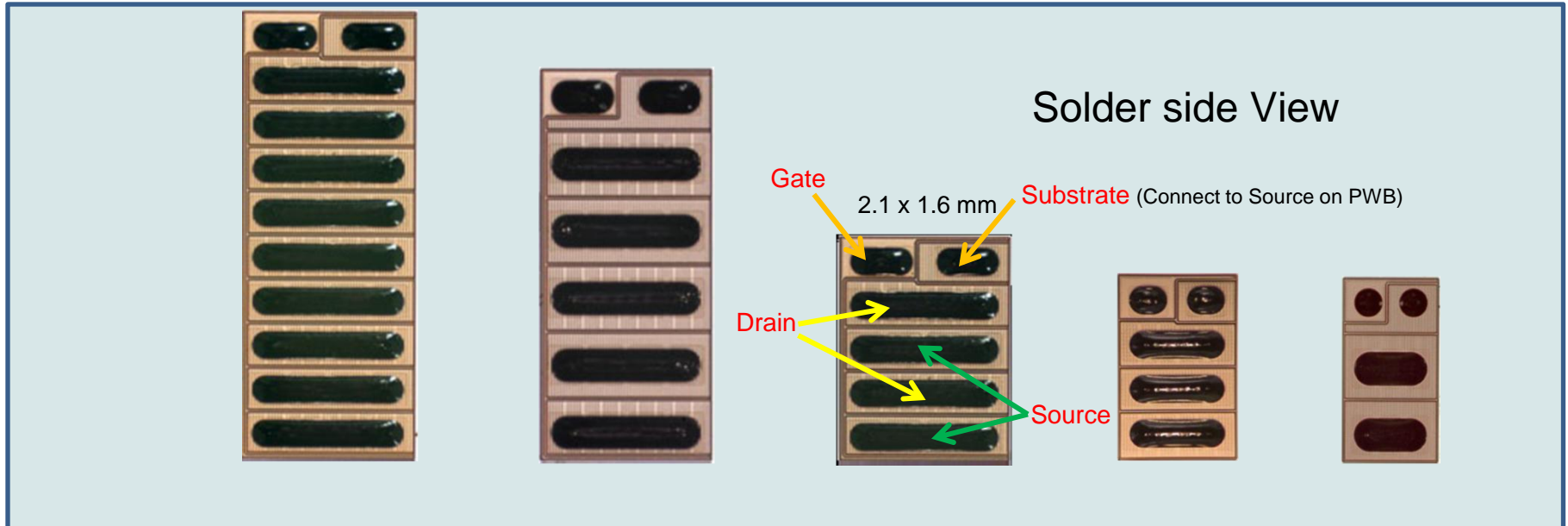
ZVS Voltage Mode Class D

- Switch voltage rating = Supply (V_{DD}).
- C_{OSS} Voltage is transitioned by the ZVS tank
- ZVS tank circuit does not carry load current
- Coil Voltage = $\frac{1}{2} \cdot V_{DD}$ [V_{RMS}]

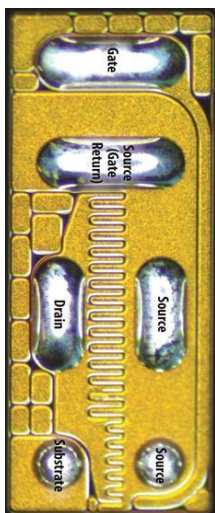


- Low C_{ISS} and C_{OSS}
- Zero Q_{RR}
- Low $R_{DS(on)}$ for equal voltage rating
- Low profile
- Gate Drivers available:
 - LM5113
 - LM5114
 - UCC27611
- dv/dt immunity

eGaN FET Low Voltage Family



Part Number	Package (mm)	V _{DS} (V)	V _{GS} (V)	R _{DS(on)} @5V (mΩ)	Q _G @5 V Typ. (nC)	Q _{GS} Typ. (nC)	Q _{GD} Typ. (nC)	R _G Typ. (Ω)	V _{th} Typ. (V)	Q _{RR} (nC)	I _D (A)	T _J Max. (°C)
EPC2015	LGA 4.1x1.6	40	6	4	10.5	3	2.2	0.6	1.4	0	33	150
EPC2014	LGA 1.7x1.1	40	6	16	2.5	0.67	0.48	0.6	1.4	0	10	150
EPC2001	LGA 4.1x1.6	100	6	7	8	2.3	2.2	0.6	1.4	0	25	125
EPC2016	LGA 2.1x1.6	100	6	16	4.1	0.93	0.75	0.6	1.4	0	11	125
EPC2007	LGA 1.7x1.1	100	6	30	2.1	0.5	0.6	0.6	1.4	0	6	125
EPC2010	LGA 3.6x1.6	200	6	25	5	1.3	1.7	0.6	1.4	0	12	125
EPC2012	LGA 1.7x0.9	200	6	100	1.5	0.33	0.57	0.6	1.4	0	3	125



EPC Part No.	BV (V)	Max. $R_{DS(ON)}$ (m Ω) ($V_{GS} = 5V$, $I_D = 0.5 A$)	Min. Peak I_d (A) (Pulsed, 25 $^{\circ}C$, $T_{pulse} = 300 \mu s$)	Typical Charge (pC)					Typical Capacitance (pF) ($V_{DS} = 20 V$; $V_{GS} = 0 V$)		
				Q_G	Q_{GD}	Q_{GS}	Q_{OSS}	Q_{RR}	C_{ISS}	C_{OSS}	C_{RSS}
EPC8004	40	125	7.5	358	31	110	493	0	45	17	0.4
EPC8007	40	160	6	302	25	97	406	0	39	14	0.3
EPC8008	40	325	2.9	177	12	67	211	0	25	8	0.2
EPC8009	65	138	7.5	380	36	116	769	0	47	17	0.4
EPC8005	65	275	3.8	218	18	77	414	0	29	9.7	0.2
EPC8002	65	530	2	141	9.4	59	244	0	21	5.9	0.1
EPC8003	100	300	5	315	34	110	1100	0	38	18	0.2
EPC8010	100	160	7.5	354	32	109	1509	0	47	18	0.2

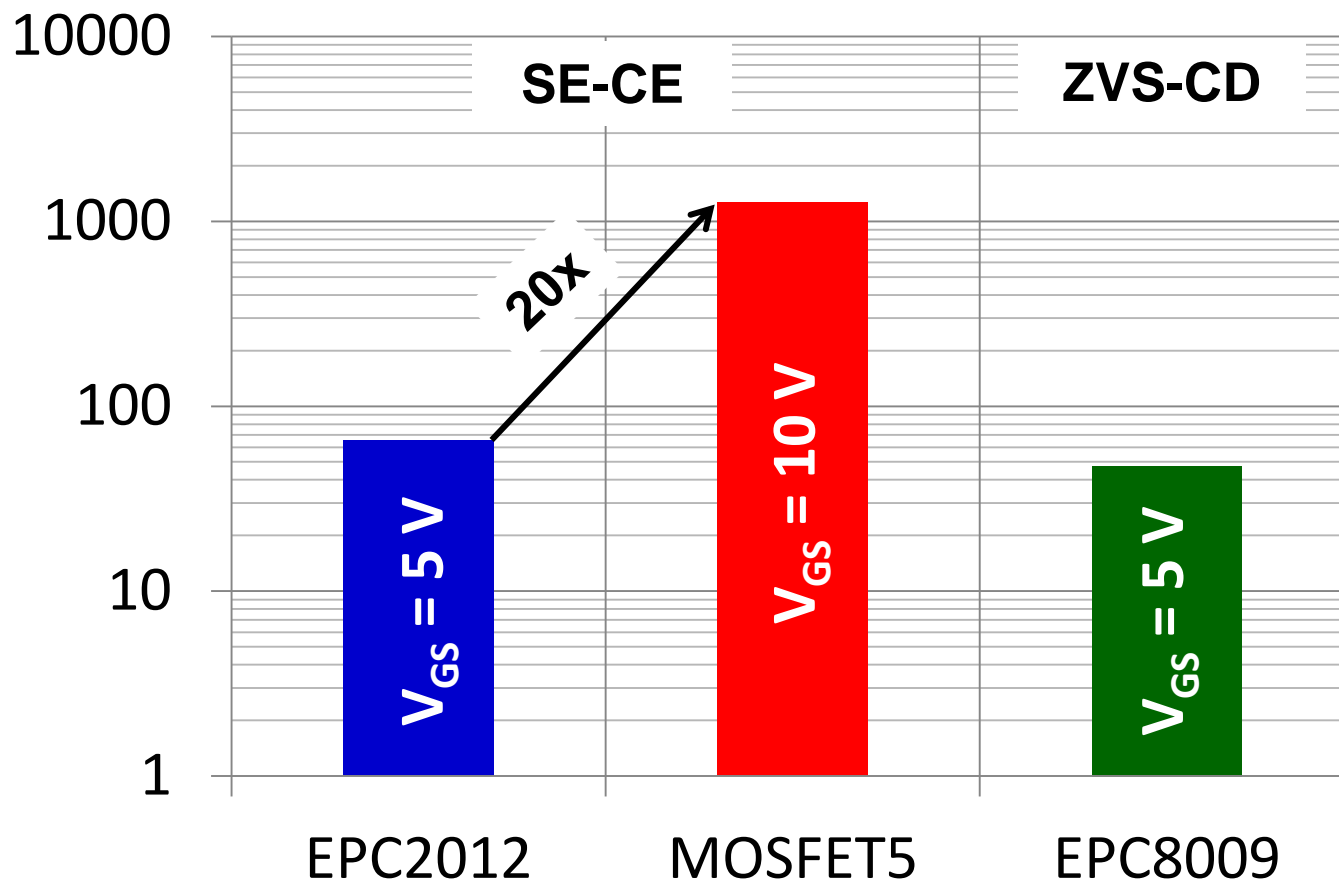
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- All topologies are ZVS: $Q_G - Q_{GD}$ only
- C_{OSS} is “absorbed” in matching – excluded
- Q_{RR} ignored – poorly defined & eGaN FETs are zero and assuming optimal operation
- C_{OSS} still important:
 - Drives off resonance losses
 - Determines design-ability

$$FOM_{WPT} = R_{DS(on)} \cdot (Q_G - Q_{GD})$$

Figure of Merit Device Comparison

FoM_{WPT} [nC·mΩ]



$$FOM_{WPT} = R_{DS(on)} \cdot (Q_G - Q_{GD})$$

- Operating setup:
 - On resonance tuned source coil
 - Device tuning is fixed
- Performance testing:
 - Fixed load, variable supply (Peak Performance)
 - Fixed load voltage (15 V), variable DC load (20:1 ratio – 10 Ω through 200 Ω) (Load Regulation)
 - Category 3 power limited Constant Coil Current, emulates charging smart phone

Amplifiers:

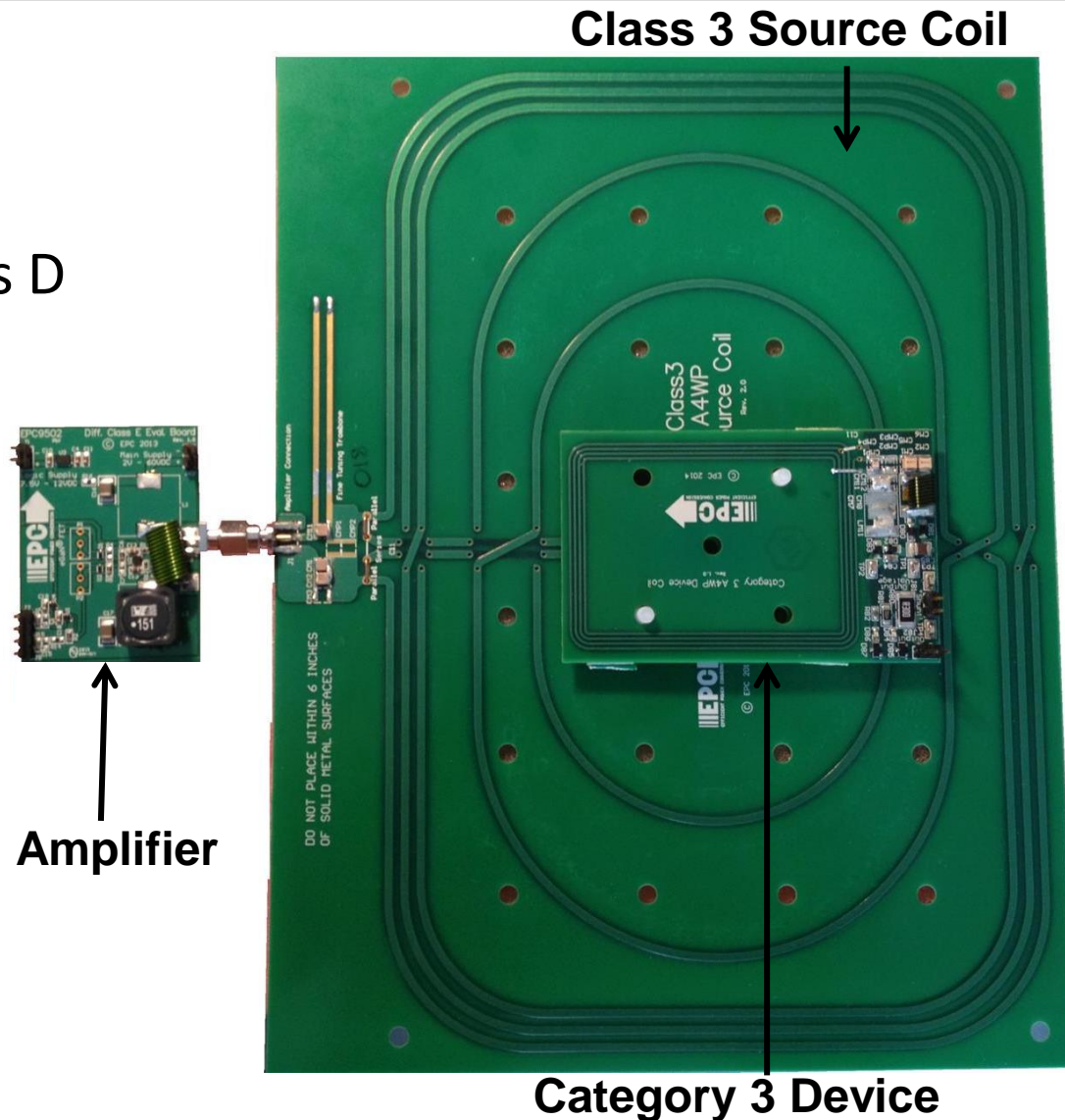
- EPC9502 (EPC2012) Class E
- EPC9503 (MOSFET5) Class E
- EPC9029 (EPC8009) ZVS Class D

Source Coil:

- A4WP Class 3 Compliant

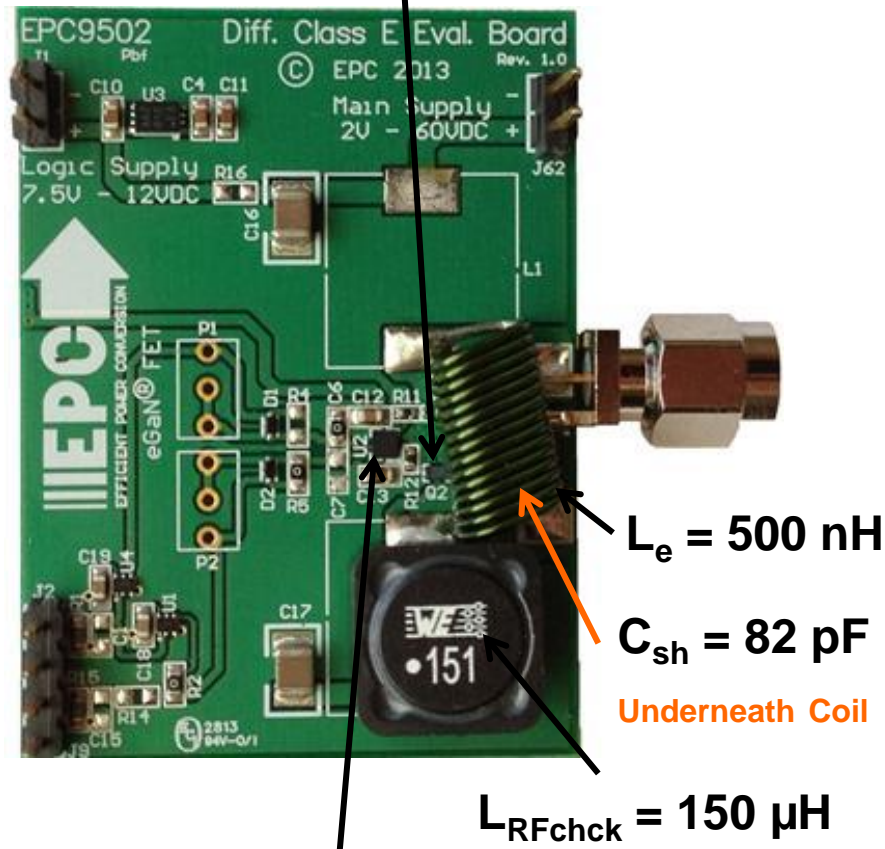
Device Coil:

- A4WP Category 3 Compliant

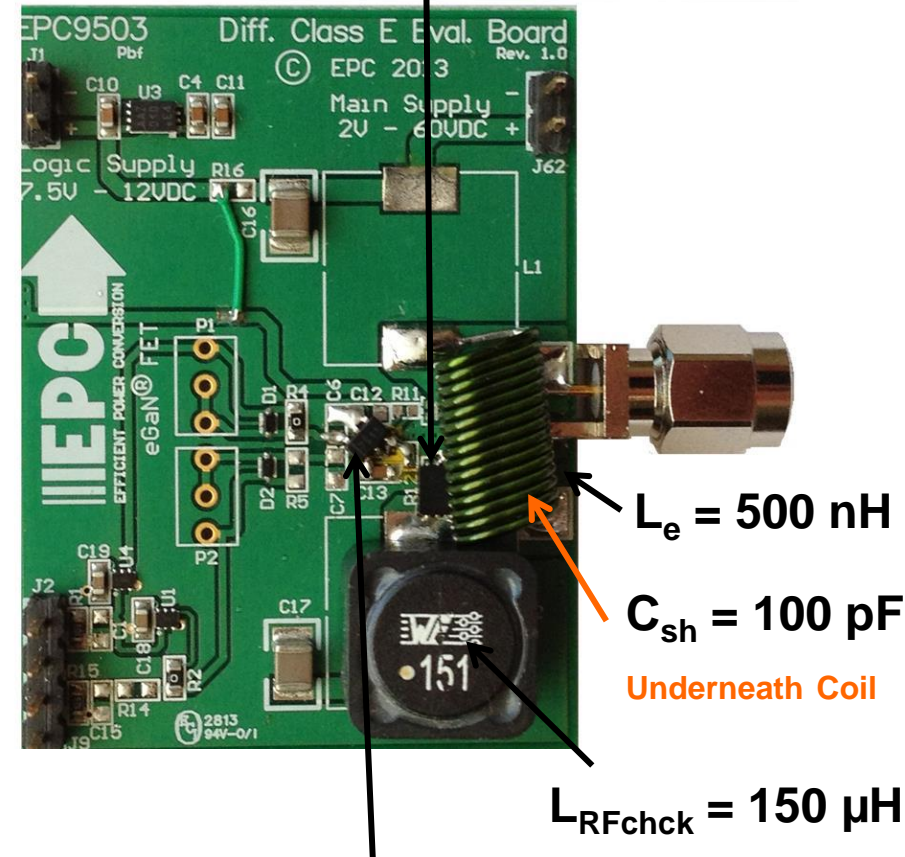


Class E Amplifiers

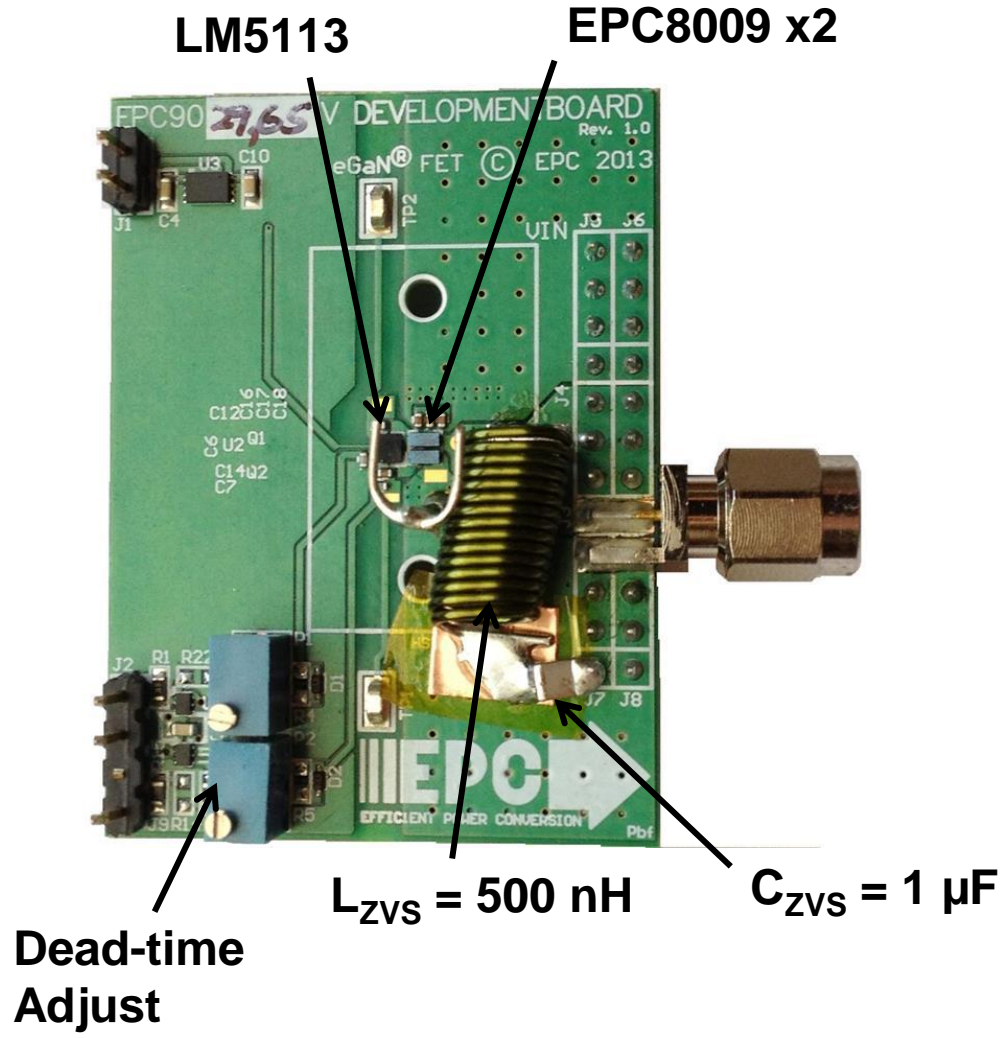
EPC2012



MOSFET 5

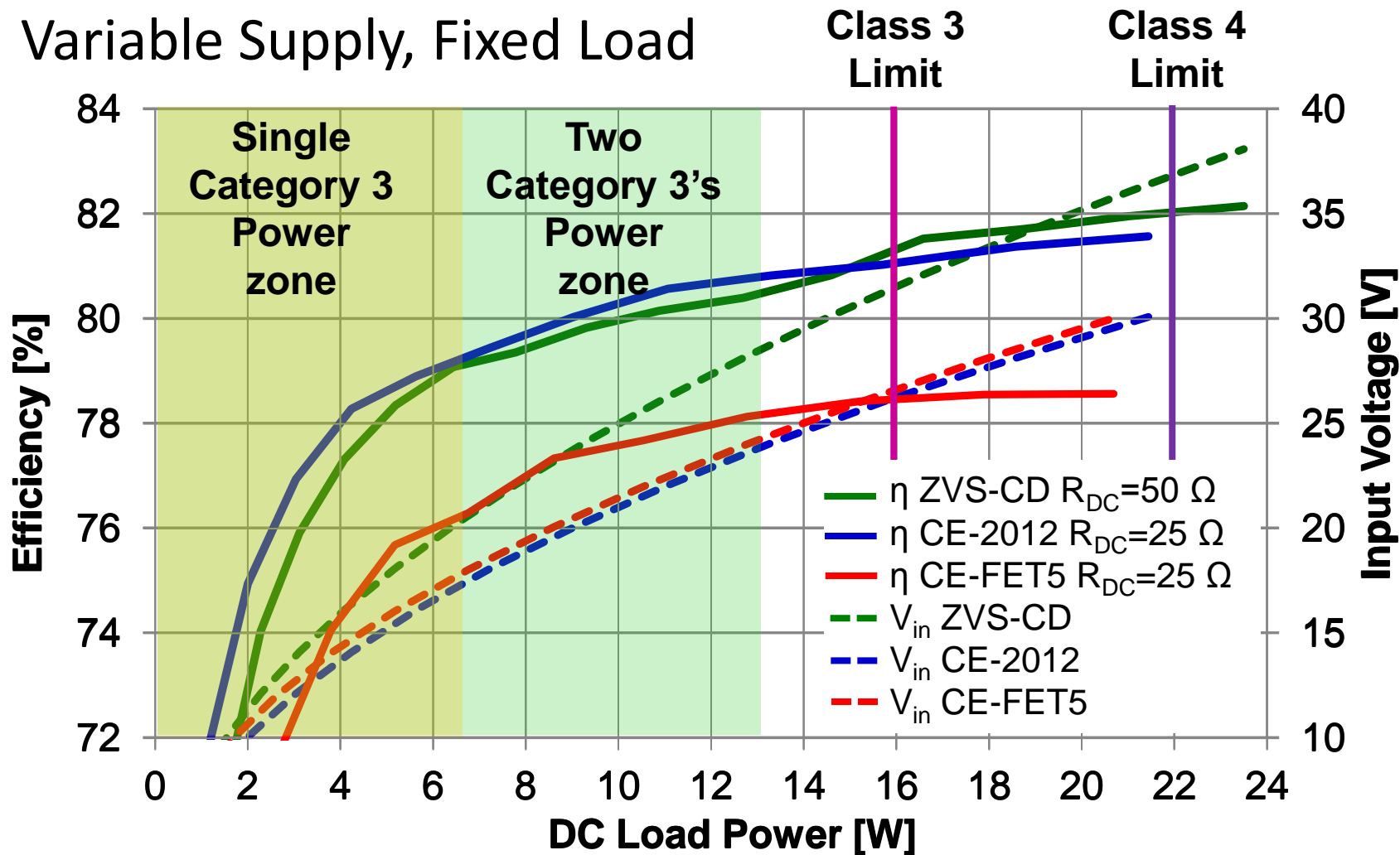


eGaN FET ZVS Class D Amplifier

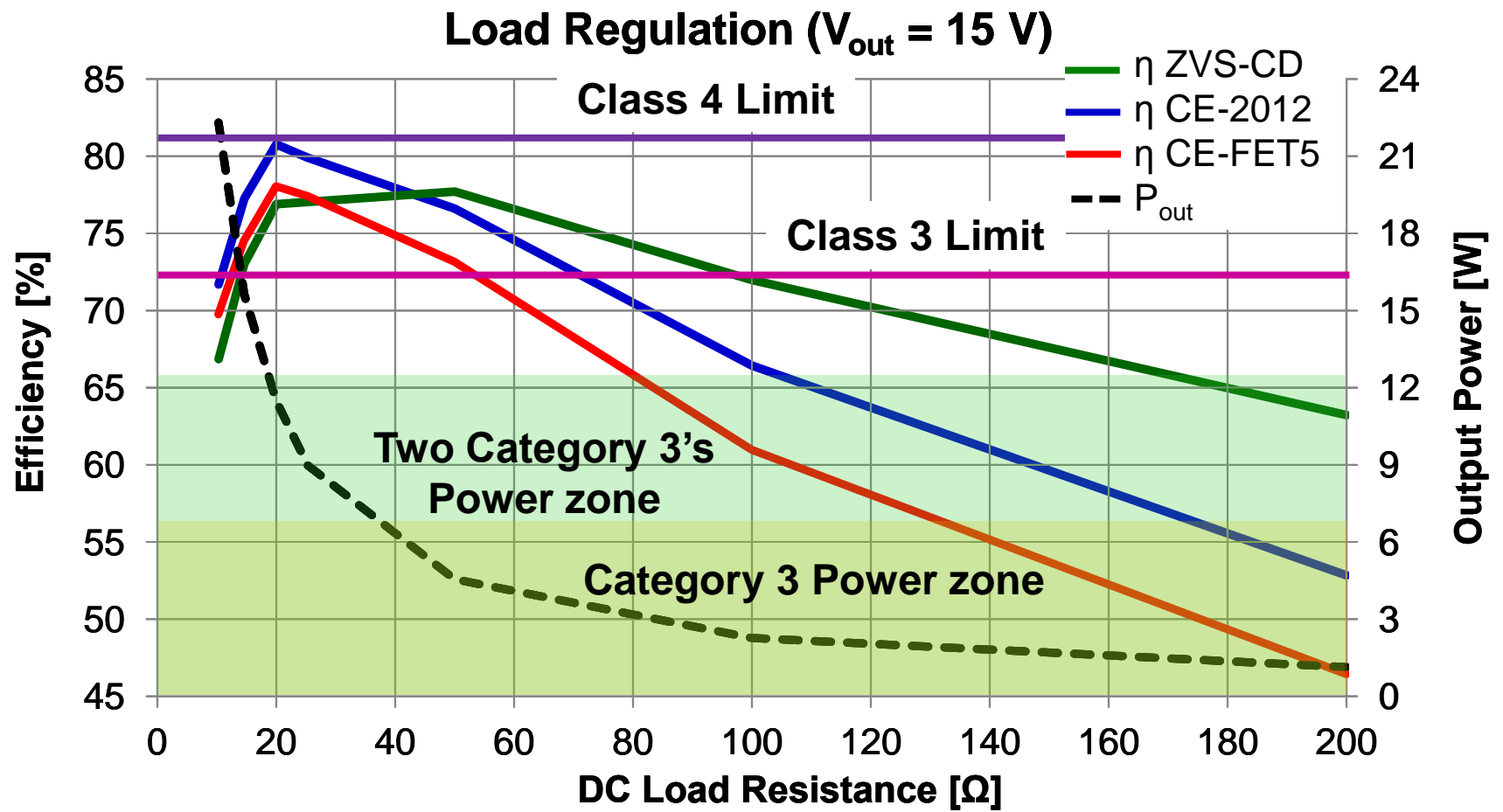


Peak Efficiency, Single load capability

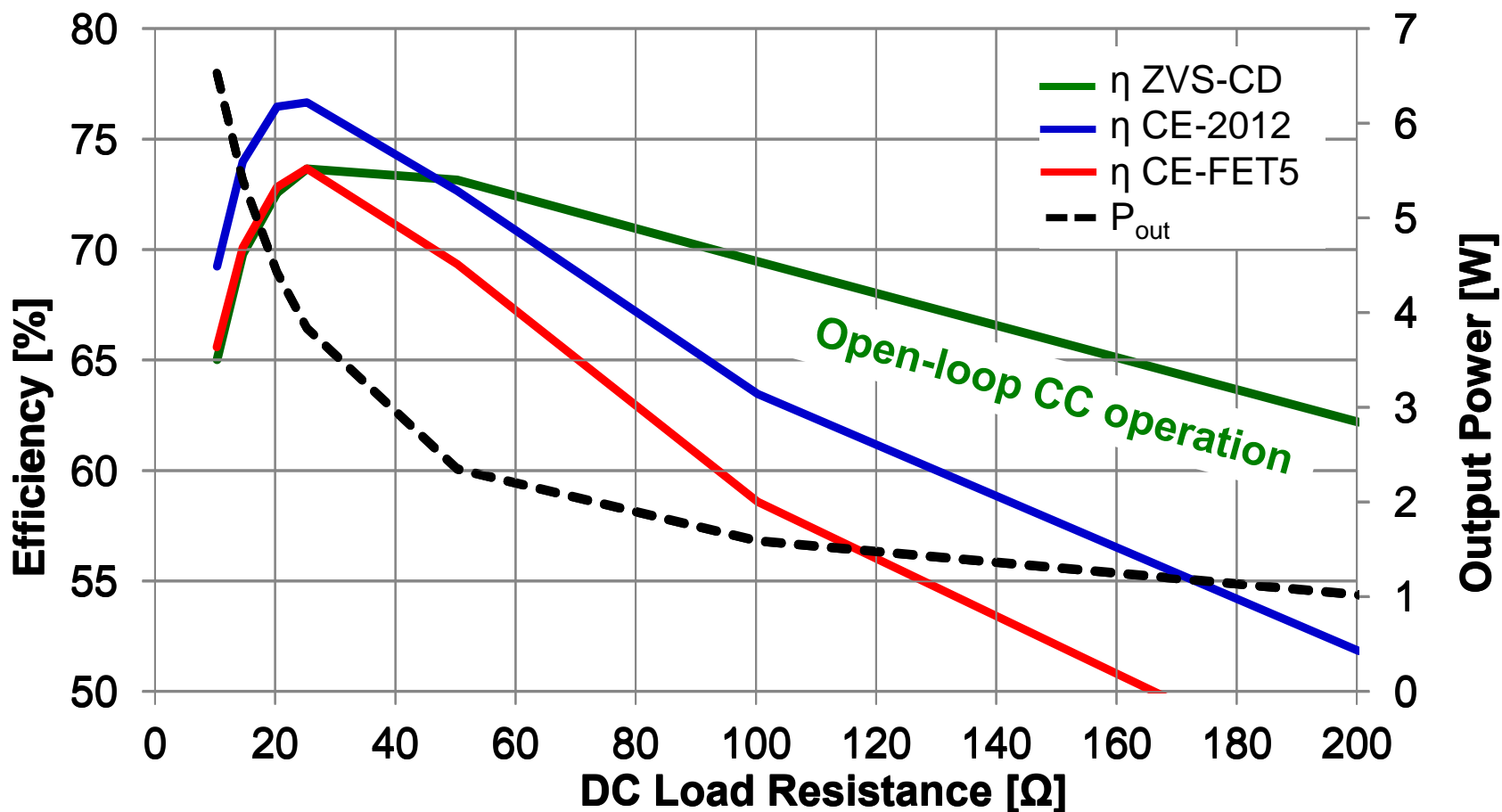
Variable Supply, Fixed Load



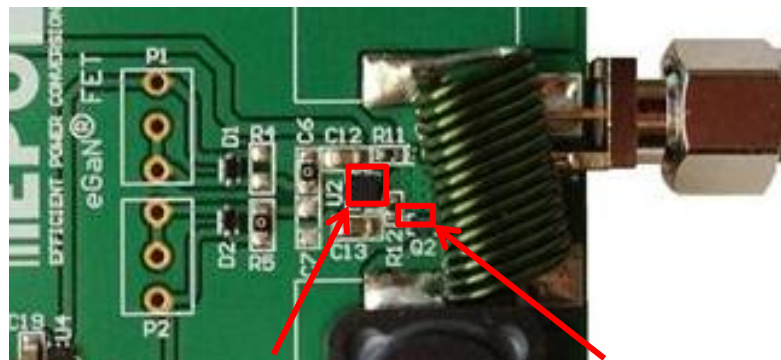
Load Regulation Results



Evaluation Load profile emulating charging Smart Phone A4WP Category 3 Device

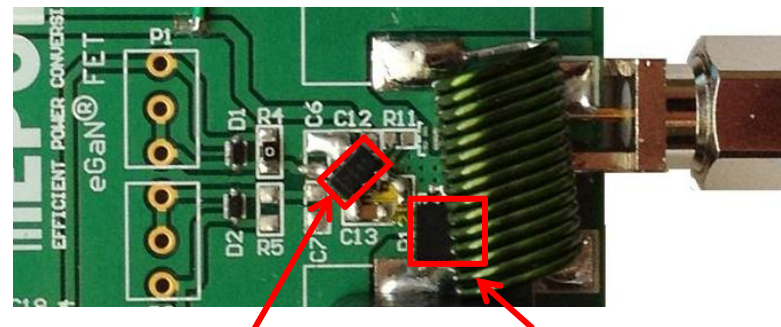


Class E Thermal Performance



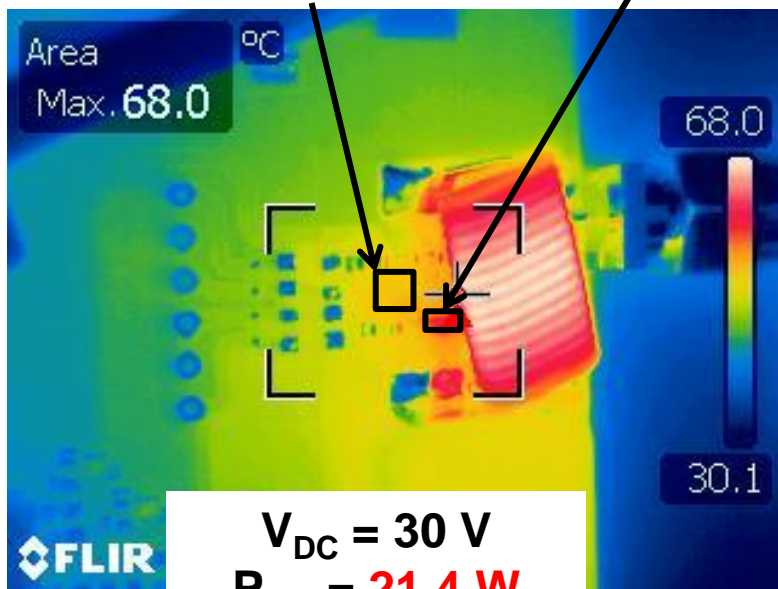
LM5113

EPC2012

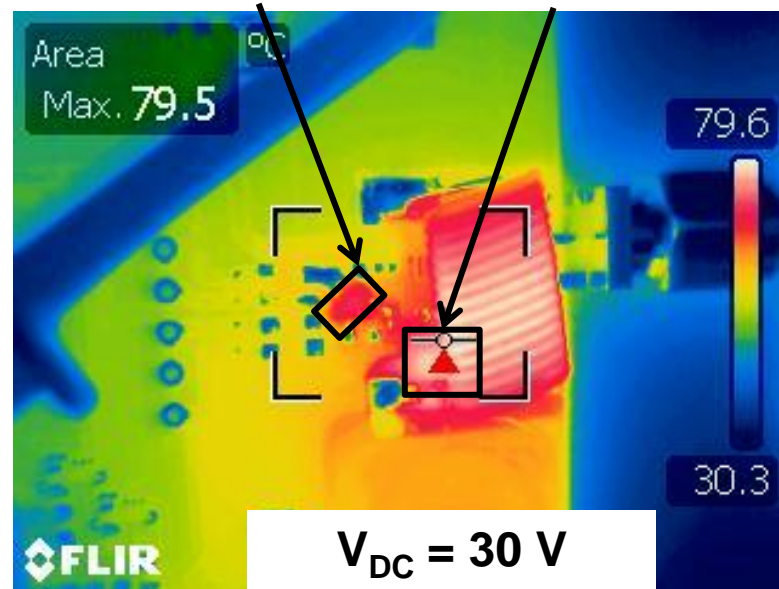


UCC27511

MOSFET5

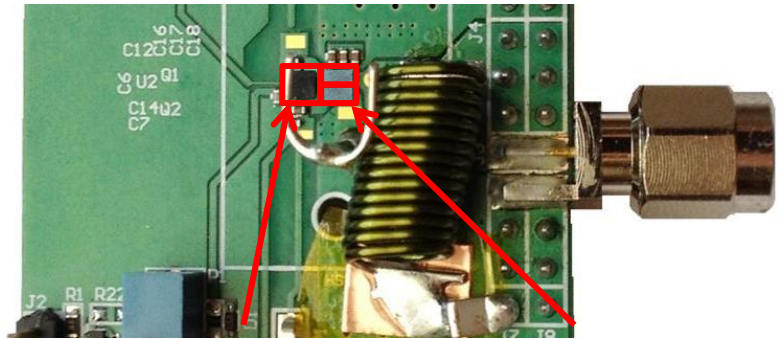


$V_{DC} = 30\text{ V}$
 $P_{out} = 21.4\text{ W}$
 $R_{DCload} = 25.3\ \Omega$



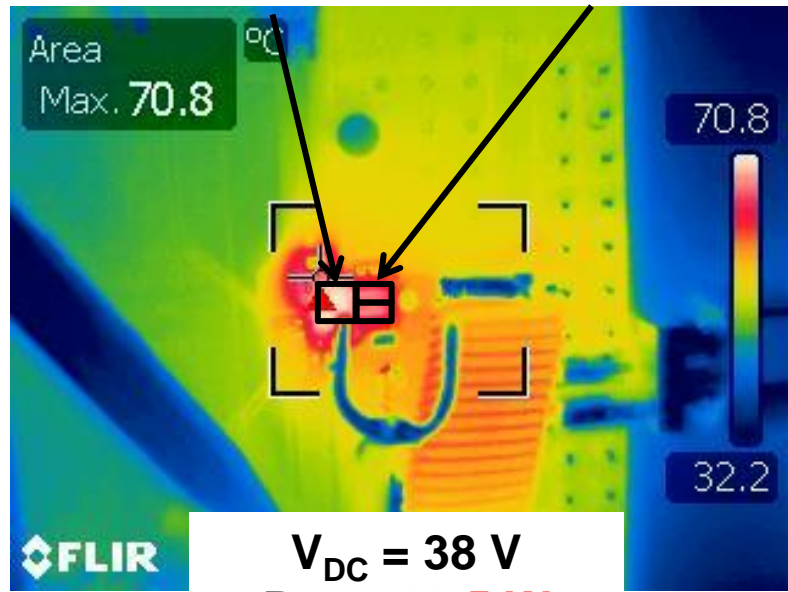
$V_{DC} = 30\text{ V}$
 $P_{out} = 20.7\text{ W}$
 $R_{DCload} = 25.3\ \Omega$

ZVS Class D Thermal Performance



LM5113

EPC8009



$V_{DC} = 38 \text{ V}$
 $P_{out} = 23.5 \text{ W}$
 $R_{DCload} = 50.3 \Omega$

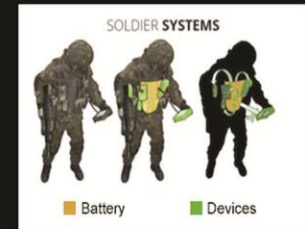
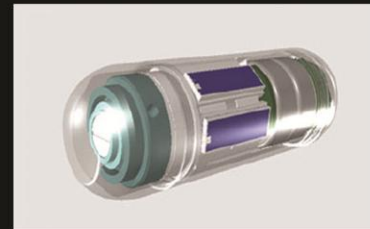
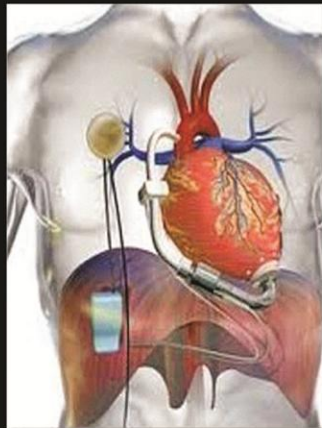
eGaN[®] FETs are disruptive in Wireless Energy:

- Enable Wireless Power
- Yield Higher Efficiency than MOSFETs
 - Including over a wide load range
- Can easily operate at 6.78 MHz
- Easy to use
- Drive new topologies e.g. ZVS Class D
- Growing support e.g. Gate drivers and products use them.

EPC

EFFICIENT POWER CONVERSION

Where is GaN going...



- Emulates Mobile phone charging
- Based on ZVS class D operating with 250 mA fixed supply current into tuned source coil
- Max. output power set at 10 Ω DC load Resistance (assumes typical post regulator current draw)

